



LT1122

# Fast Settling, JFET Input Operational Amplifier

## FEATURES

- 100% Tested Settling Time to 1mV at Sum Node, 10V Step Tested with Fixed Feedback Capacitor
 

340ns Typ
540ns Max
- Slew Rate
 

60V/μs Min
------------
- Gain Bandwidth Product
 

14MHz
-------
- Power Bandwidth (20Vp-p)
 

1.2 MHz
---------
- Unity Gain Stable; Phase Margin
 

60°
-----
- Input Offset Voltage
 

600μV Max
-----------
- Input Bias Current
 

25°C	75pA Max
70°C	600pA Max
- Input Offset Current
 

25°C	40pA Max
70°C	150pA Max
- Low Distortion

## APPLICATIONS

- Fast 12-Bit D/A Output Amplifiers
- High Speed Buffers
- Fast Sample and Hold Amplifiers
- High Speed Integrators
- Voltage to Frequency Converters
- Active Filters
- Log Amplifiers
- Peak Detectors

## DESCRIPTION

The LT1122 JFET input operational amplifier combines high speed and precision performance.

A unique poly-gate JFET process minimizes gate series resistance and gate-to-drain capacitance, facilitating wide bandwidth performance, without degrading JFET transistor matching.

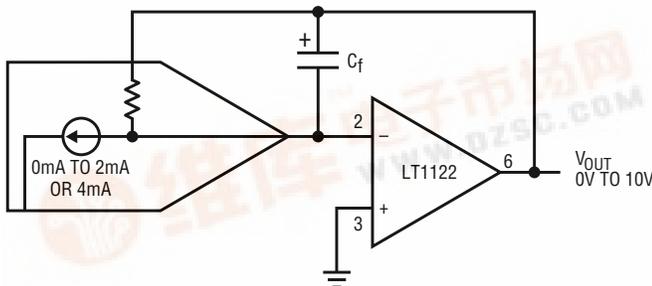
It slews at 80V/μs and settles in 340ns. The LT1122 is internally compensated to be unity gain stable, yet it has a bandwidth of 14MHz at a supply current of only 7mA. Its speed makes the LT1122 an ideal choice for fast settling 12-bit data conversion and acquisition systems.

The LT1122 offset voltage of 120μV, and voltage gain of 500,000 also support the 12-bit accurate applications.

The input bias current of 10pA and offset current of 4pA combined with its speed allow the LT1122 to be used in such applications as high speed sample and hold amplifiers, peak detectors, and integrators.

## TYPICAL APPLICATION

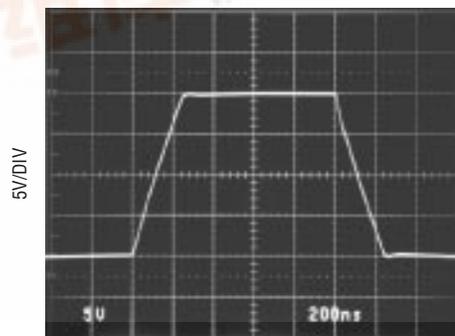
12-Bit Voltage Output D/A Converter



12-BIT CURRENT OUTPUT D/A CONVERTER  
 $C_f = 5pF$  TO  $17pF$   
 (DEPENDENT ON D/A CONVERTER USED)

LT1122-TA01

Large-Signal Response



200ns/DIV  
 AV = -1

1122 TA07

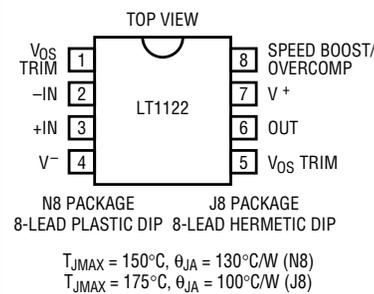
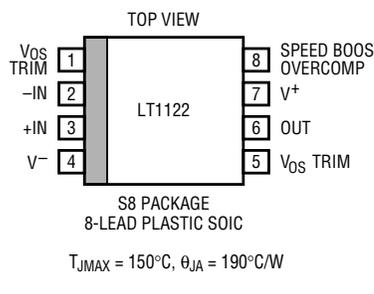


# LT1122

## ABSOLUTE MAXIMUM RATINGS

Supply Voltage .....	$\pm 20V$	Operating Temperature Range	
Differential Input Voltage .....	$\pm 40V$	LT1122AM/BM/CM/DM .....	$-55^{\circ}C$ to $125^{\circ}C$
Input Voltage .....	$\pm 20V$	LT1122AC/BC/CC/DC/CS/DS .....	$-40^{\circ}C$ to $85^{\circ}C$
Output Short Circuit Duration .....	Indefinite	Storage Temperature Range	
Lead Temperature (Soldering, 10 sec.) .....	$300^{\circ}C$	All Devices .....	$-65^{\circ}C$ to $150^{\circ}C$

## PACKAGE/ORDER INFORMATION

 <p>TOP VIEW</p> <p>LT1122</p> <p>N8 PACKAGE 8-LEAD PLASTIC DIP</p> <p>J8 PACKAGE 8-LEAD HERMETIC DIP</p> <p><math>T_{JMAX} = 150^{\circ}C, \theta_{JA} = 130^{\circ}C/W</math> (N8)  <math>T_{JMAX} = 175^{\circ}C, \theta_{JA} = 100^{\circ}C/W</math> (J8)</p>	ORDER PART NUMBER		 <p>TOP VIEW</p> <p>LT1122</p> <p>S8 PACKAGE 8-LEAD PLASTIC SOIC</p> <p><math>T_{JMAX} = 150^{\circ}C, \theta_{JA} = 190^{\circ}C/W</math></p>	ORDER PART NUMBER
	LT1122AMJ8	LT1122CCJ8		ORDER PART NUMBER
	LT1122BMJ8	LT1122DCJ8		LT1122CS8
	LT1122CMJ8	LT1122ACN8		LT1122DS8
LT1122DMJ8	LT1122BCN8	PART MARKING		
LT1122ACJ8	LT1122CCN8	1122C		
LT1122BCJ8	LT1122DCN8	1122D		

Consult factory for Industrial grade parts.

## ELECTRICAL CHARACTERISTICS $V_S = \pm 15V, T_A = 25^{\circ}C, V_{CM} = 0V$ unless otherwise noted. (Note 1)

SYMBOL	PARAMETER	CONDITIONS	LT1122AM/BM LT1122AC/BC			LT1122CM/DM LT1122CC/DC LT1122CS/DS			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	
$V_{OS}$	Input Offset Voltage			120	600		130	900	$\mu V$
$I_{OS}$	Input Offset Current			4	40		5	50	$\mu A$
$I_B$	Input Bias Current			10	75		12	100	$\mu A$
	Input Resistance								$\Omega$
	Differential	$V_{CM} = -10V$ to $+8V$		$10^{12}$			$10^{12}$		$\Omega$
	Common Mode	$V_{CM} = +8V$ to $+11V$		$10^{12}$			$10^{12}$		$\Omega$
	Input Capacitance			4			4		$\mu F$
$S_R$	Slew Rate	$A_V = -1$	60	80		50	75		$V/\mu s$
	Settling Time (Note 2)	$+10V$ to $0V, -10V$ to $0V$ 100% Tested: A and C Grades to 1mV at Sum Node B and D Grades to 1mV at Sum Node All Grades to 0.5mV at Sum Node		340	540		350	590	ns
				350			360		ns
				450			470		ns
GBW	Gain Bandwidth Product			14			13		MHz
	Power Bandwidth	$V_{OUT} = 20V_{p-p}$		1.2			1.1		MHz
$A_{VOL}$	Large Signal Voltage Gain	$V_{OUT} = \pm 10V, R_L = 2k\Omega$ $V_{OUT} = \pm 10V, R_L = 600\Omega$	180	500		150	450		$V/mV$
			130	250		110	220		$V/mV$
CMRR	Common Mode Rejection Ratio	$V_{CM} = \pm 10V$	83	99		80	98		dB
	Input Voltage Range	(Note 3)	$\pm 10.5$	$\pm 11$		$\pm 10.5$	$\pm 11$		V
PSRR	Power Supply Rejection Ratio	$V_S = \pm 10V$ to $\pm 18V$	86	103		82	101		dB
	Input Noise Voltage	0.1Hz to 10Hz		3.0			3.3		$\mu V_{p-p}$
	Input Noise Voltage Density	$f_0 = 100Hz$ $f_0 = 10kHz$		25			27		$nV/\sqrt{Hz}$
				14			15		$nV/\sqrt{Hz}$
	Input Noise Current Density	$f_0 = 100Hz, f_0 = 10kHz$		2			2		$fA/\sqrt{Hz}$

**ELECTRICAL CHARACTERISTICS**  $V_S = \pm 15V$ ,  $T_A = 25^\circ C$ ,  $V_{CM} = 0V$  unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	LT1122AM/BM LT1122AC/BC			LT1122CM/DM LT1122CC/DC LT1122CS/DS			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	
$V_{OUT}$	Output Voltage Swing	$R_L = 2k\Omega$	$\pm 12$	$\pm 12.5$		$\pm 12$	$\pm 12.5$		V
		$R_L = 600\Omega$	$\pm 11.5$	$\pm 12$		$\pm 11.5$	$\pm 12$		V
$I_S$	Supply Current		7.5	10		7.8	11		mA
	Minimum Supply voltage	(Note 4)	$\pm 5$			$\pm 5$			V
	Offset Adjustment Range	$R_{POT} \geq 10k$ , Wiper to $V^+$	$\pm 4$	$\pm 10$		$\pm 4$	$\pm 10$		mV

$V_S = \pm 15V$ ,  $V_{CM} = 0V$ ,  $0^\circ C \leq T_A \leq 70^\circ C$ , unless otherwise noted. (Note 1)

SYMBOL	PARAMETER	CONDITIONS		LT1122AC/BC			LT1122CC/DC LT1122CS/DS			UNITS
				MIN	TYP	MAX	MIN	TYP	MAX	
$V_{OS}$	Input Offset Voltage		•	350	1400		400	2000	$\mu V$	
	Average Temperature Coefficient of Input Offset Voltage		•	5	18		6	25	$\mu V/^\circ C$	
$I_{OS}$	Input Offset Current		•	12	150		15	200	pA	
$I_B$	Input Bias Current		•	80	600		90	800	pA	
$A_{VOL}$	Large Signal Voltage Gain	$V_{OUT} = \pm 10V$ , $R_L \geq 2k\Omega$	•	120	380		100	340	V/mV	
CMRR	Common Mode Rejection Ratio	$V_{CM} = \pm 10V$	•	82	98		78	96	dB	
PSRR	Power Supply Rejection Ratio	$V_S = \pm 10V$ to $\pm 17V$	•	84	101		80	99	dB	
	Input Voltage Range		•	$\pm 10$	$\pm 10.8$		$\pm 10$	$\pm 10.8$	V	
$V_{OUT}$	Output Voltage Swing	$R_L = 2k\Omega$	•	$\pm 11.5$	$\pm 12.4$		$\pm 11.5$	$\pm 12.4$	V	
$S_R$	Slew Rate	$A_V = -1$	•	50	70		40	65	V/ $\mu s$	

$V_S = \pm 15V$ ,  $V_{CM} = 0V$ ,  $-55^\circ C \leq T_A \leq 125^\circ C$ , unless otherwise noted. (Note 1)

SYMBOL	PARAMETER	CONDITIONS		LT1122AM/BM			LT1122CM/DM			UNITS
				MIN	TYP	MAX	MIN	TYP	MAX	
$V_{OS}$	Input Offset Voltage		•	650	2400		800	3400	$\mu V$	
	Average Temperature Coefficient of Input Offset Voltage		•	6	18		7	25	$\mu V/^\circ C$	
$I_{OS}$	Input Offset Current		•	0.5	6		0.6	9	nA	
$I_B$	Input Bias Current		•	6	25		7	35	nA	
$A_{VOL}$	Large Signal Voltage Gain	$V_{OUT} = \pm 10V$ , $R_L \geq 2k\Omega$	•	70	230		60	200	V/mV	
CMRR	Common Mode Rejection Ratio	$V_{CM} = \pm 10V$	•	80	97		76	94	dB	
PSRR	Power Supply Rejection Ratio	$V_S = \pm 10V$ to $\pm 17V$	•	83	100		78	98	dB	
	Input Voltage Range		•	$\pm 10$	$\pm 10.5$		$\pm 10$	$\pm 10.5$	V	
$V_{OUT}$	Output Voltage Swing	$R_L = 2k\Omega$	•	$\pm 11.3$	$\pm 12.1$		$\pm 11.3$	$\pm 12.1$	V	
$S_R$	Slew Rate	$A_V = -1$	•	45	60		35	55	V/ $\mu s$	

The • denotes the specifications which apply over the full operating temperature range.

**Note 1:** The LT1122 is measured in an automated tester in less than one second after application of power. Depending on the package used, power dissipation, heat sinking, and air flow conditions, the fully warmed up chip temperature can be  $10^\circ C$  to  $50^\circ C$  higher than the ambient temperature.

**Note 2:** Settling time is 100% tested for A and C grades using the settling time test circuit shown. This test is not included in quality assurance sample testing.

**Note 3:** Input voltage range functionality is assured by testing offset voltage at the input voltage range limits to a maximum of 4mV (A, B grades), to 5.7mV (C, D grades).

**Note 4:** Minimum supply voltage is tested by measuring offset voltage to 7mV maximum at  $\pm 5V$  supplies.

**Note 5:** The LT1122 is not tested and not quality-assurance-sampled at  $-40^\circ C$  and at  $85^\circ C$ . These specifications are guaranteed by design, correlation and/or inference from  $-55^\circ C$ ,  $0^\circ C$ ,  $25^\circ C$ ,  $70^\circ C$  and/or  $125^\circ C$  tests.

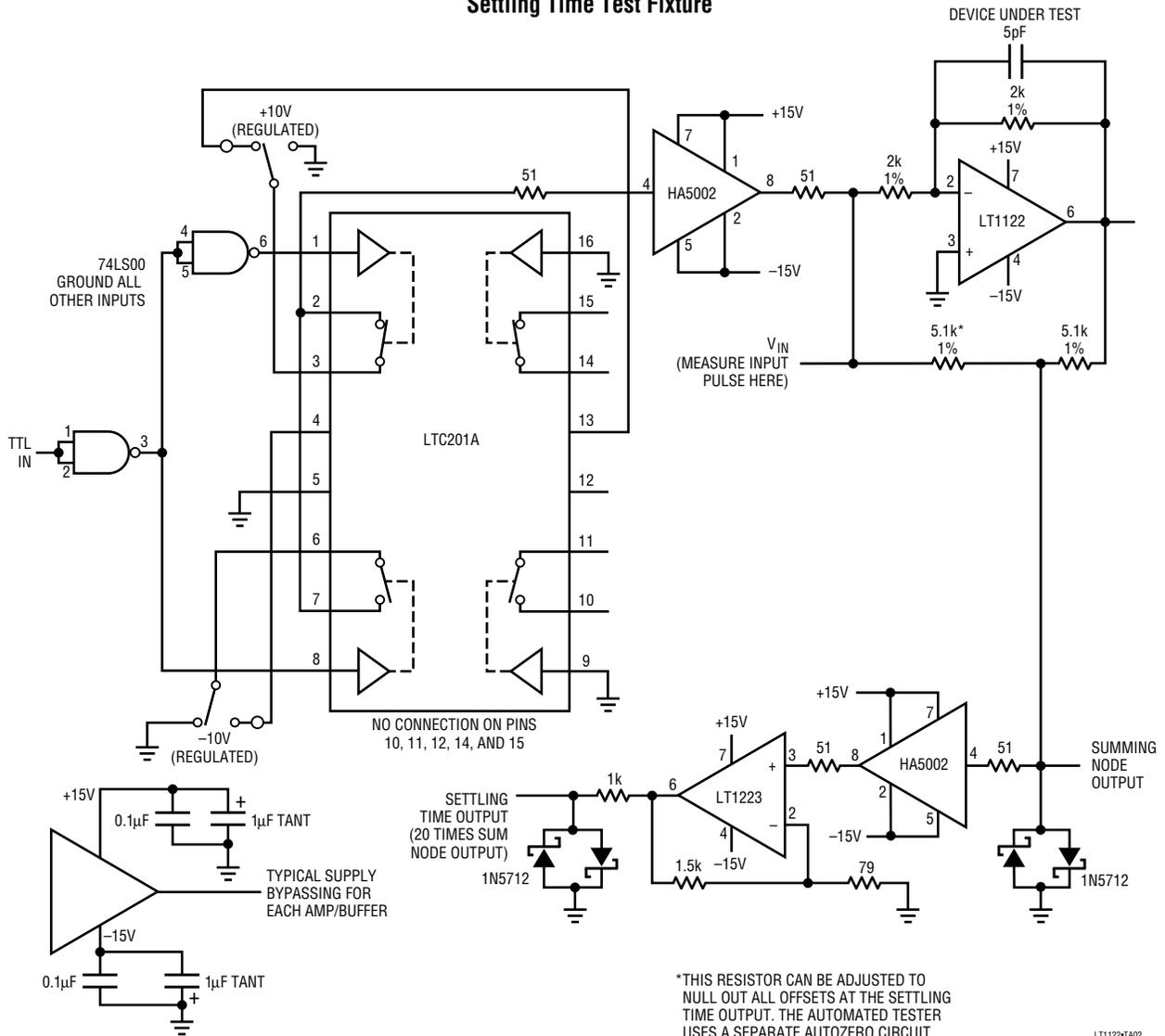
# LT1122

## ELECTRICAL CHARACTERISTICS

$V_S = \pm 15V$ ,  $V_{CM} = 0V$ ,  $-40^\circ C \leq T_A \leq 85^\circ C$ , unless otherwise noted. (Note 5)

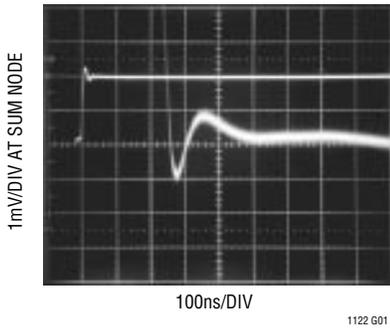
SYMBOL	PARAMETER	CONDITIONS	LT1122AC/BC			LT1122CC/DC LT1122CS/DS			UNITS
			MIN	TYP	MAX	MIN	TYP	MAX	
$V_{OS}$	Input Offset Voltage		●	450	1900		500	2700	$\mu V$
	Average Temperature Coefficient of Input Offset Voltage		●	6	20		7	28	$\mu V/^\circ C$
$I_{OS}$	Input Offset Current		●	30	600		40	900	$\mu A$
$I_B$	Input Bias Current		●	230	2000		260	2700	$\mu A$
$A_{VOL}$	Large Signal Voltage Gain	$V_{OUT} = \pm 10V$ , $R_L \geq 2k\Omega$	●	95	340		80	300	V/mV
CMRR	Common Mode Rejection Ratio	$V_{CM} = \pm 10V$	●	80	98		76	96	dB
PSRR	Power Supply Rejection Ratio	$V_S = \pm 10V$ to $\pm 17V$	●	83	100		78	98	dB
	Input Voltage Range		●	$\pm 10$	$\pm 10.6$		$\pm 10$	$\pm 10.6$	V
$V_{OUT}$	Output Voltage Swing	$R_L = 2k\Omega$	●	$\pm 11.3$	$\pm 12.2$		$\pm 11.3$	$\pm 12.2$	V
$S_R$	Slew Rate	$A_V = -1$	●	45	65		35	60	V/ $\mu s$

### Settling Time Test Fixture

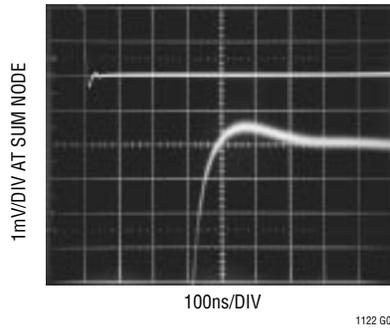


# TYPICAL PERFORMANCE CHARACTERISTICS

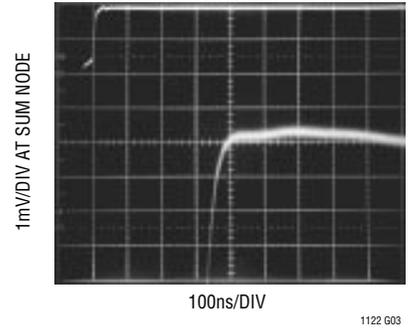
**Settling Time  
(Input From -10V to 0V)**



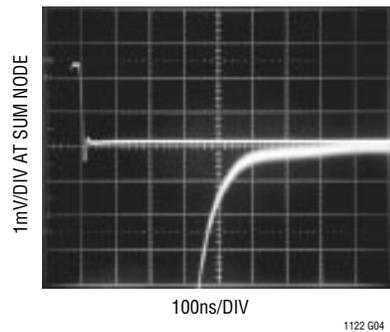
**Settling Time  
(Input From +10V to 0V)**



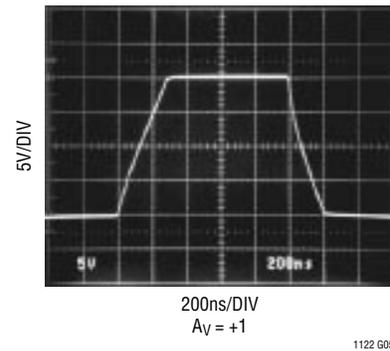
**Settling Time  
(Input From 0V to +10V)**



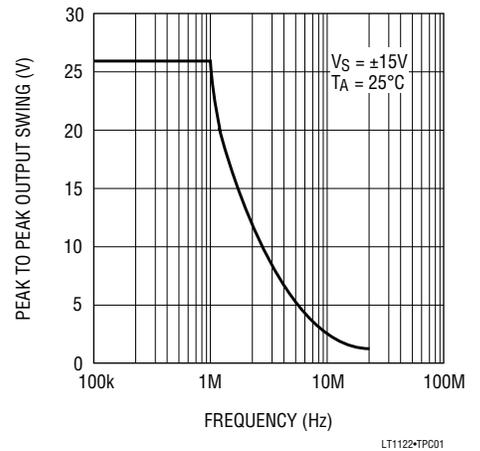
**Settling Time  
(Input From 0V to -10V)**



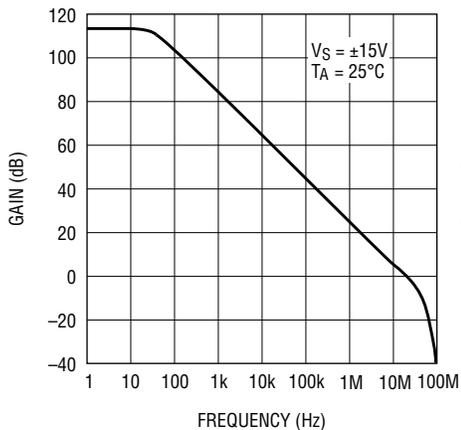
**Large Signal Response**



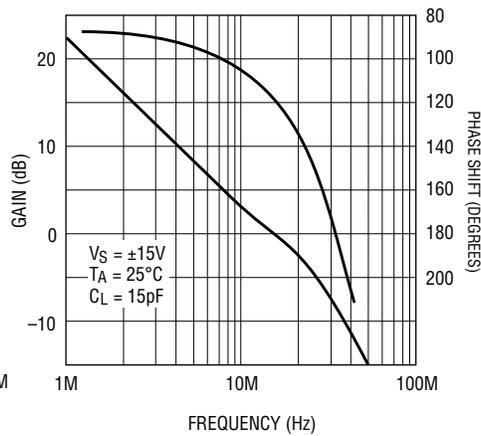
**Undistorted Output Swing vs Frequency**



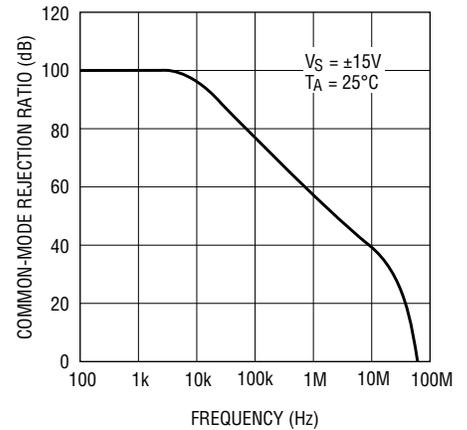
**Voltage Gain vs Frequency**



**Gain, Phase vs Frequency**

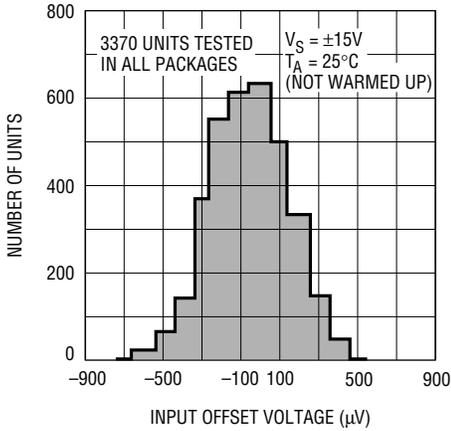


**Common Mode Rejection vs Frequency**



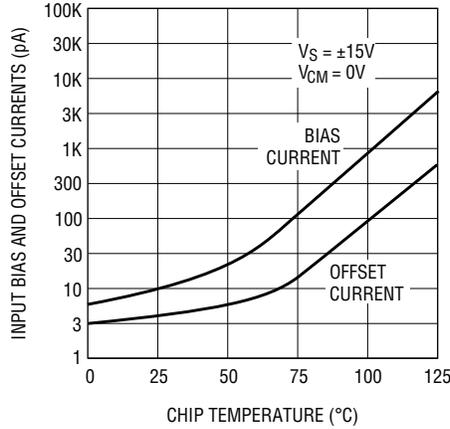
# TYPICAL PERFORMANCE CHARACTERISTICS

**Distribution of Input Offset Voltage**



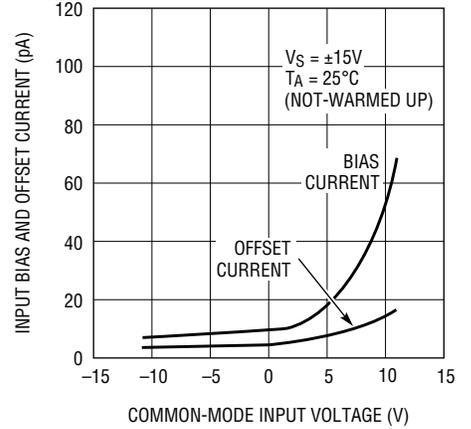
LT1122-TPC05

**Input Bias and Offset Currents Over Temperature**



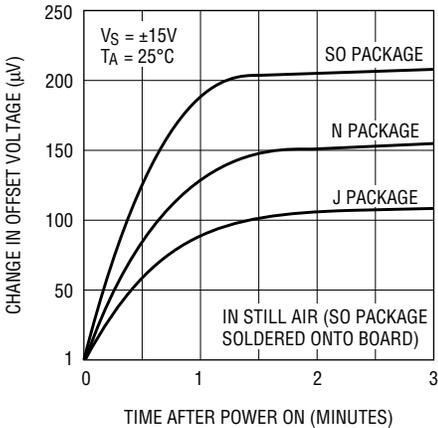
LT1122-TPC06

**Bias and Offset Currents Over The Common-Mode Range**



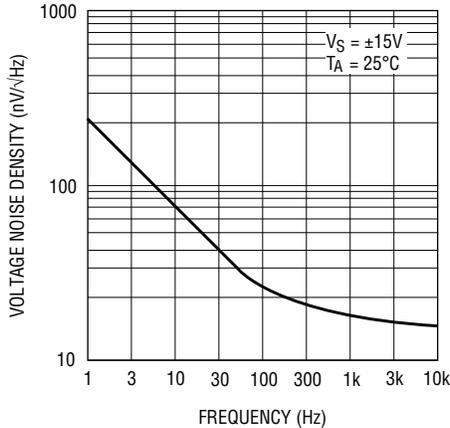
LT1122-TPC07

**Warm-up Drift**



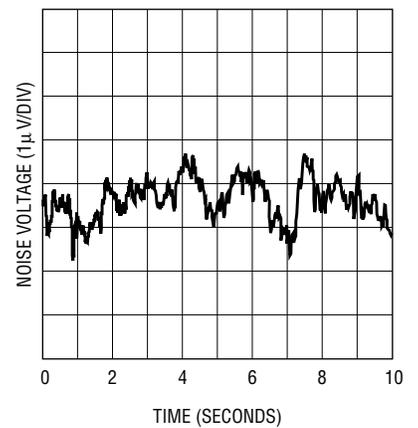
LT1122-TPC08

**Noise Spectrum**



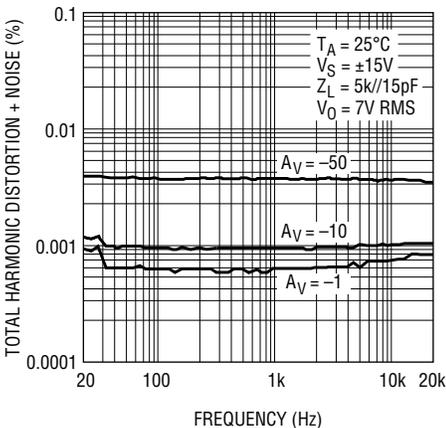
LT1122-TPC09

**0.1Hz to 10Hz Noise**



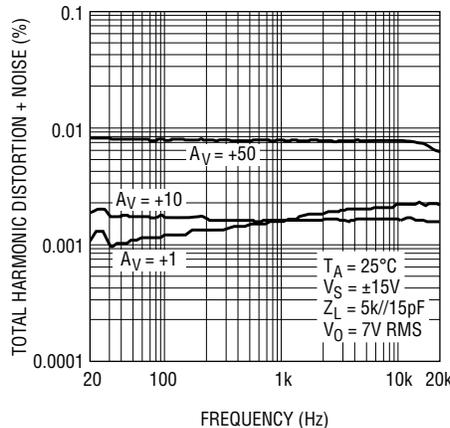
LT1122-TPC10

**Total Harmonic Distortion + Noise vs Frequency Inverting Gain**



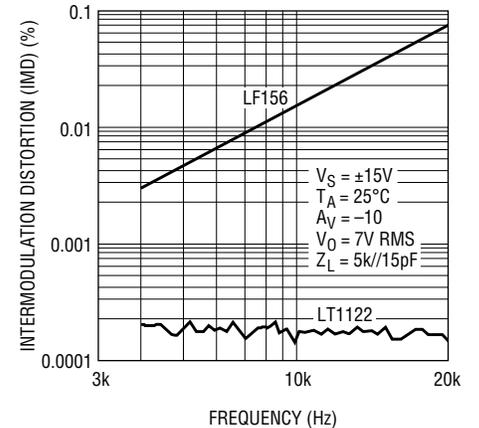
LT1122-TPC11

**Total Harmonic Distortion + Noise vs Frequency Non-Inverting Gain**



LT1122-TPC12

**Intermodulation Distortion (CCIF Method) vs Frequency LT1122 and LF156\***



\*SEE LT1115 DATA SHEET FOR DEFINITION OF CCIF TESTING

LT1122-TPC13

## APPLICATIONS INFORMATION

### Settling Time Measurements

Settling time test circuits shown on some competitive devices' data sheets require:

1. A "flat top" pulse generator. Unfortunately, flat top pulse generators are not commercially available.
2. A variable feedback capacitor around the device under test. This capacitor varies over a four to one range. Presumably, as each op amp is measured for settling time, the capacitor is fine tuned to optimize settling time for that particular device.
3. A small inductor load to optimize settling.

The LT1122's settling time is 100% tested in the test circuit shown. No "flat top" pulse generator is required. The test circuit can be readily constructed, using commercially available ICs. Of course, standard high frequency board construction techniques should be followed. All LT1122s are measured with a constant feedback capacitor. No fine tuning is required.

### Speed Boost/Overcompensation Terminal

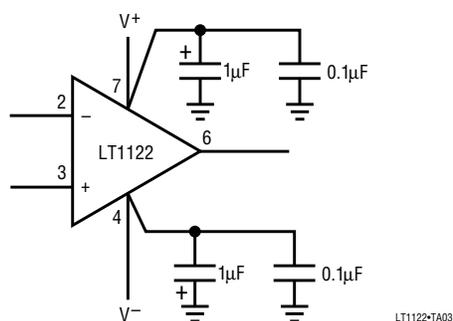
Pin 8 of the LT1122 can be used to change the input stage operating current of the device. Shorting pin 8 to the positive supply (Pin 7) increases slew rate and bandwidth by about 25%, but at the expense of a reduction in phase margin by approximately 18 degrees. Unity gain capacitive load handling decreases from typically 500pF to 100pF.

Conversely, connecting a 15k resistor from pin 8 to ground pulls 1mA out of pin 8 (with  $V^+ = 15V$ ). This reduces slew rate and bandwidth by 25%. Phase margin and capacitive load handling improve; the latter typically increasing to 800pF.

### High Speed Operation

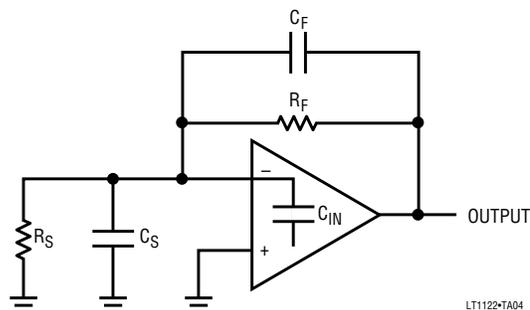
As with most high speed amplifiers, care should be taken with supply decoupling, lead dress and component placement.

The power supply connections to the LT1122 must maintain a low impedance to ground over a bandwidth of 20MHz. This is especially important when driving a significant resistive or capacitive load, since all current delivered to the load comes from the power supplies. Multiple high quality bypass capacitors are recommended for each power supply line in any critical application. A 0.1 $\mu$ F ceramic and a 1 $\mu$ F electrolytic capacitor, as shown, placed as close as possible to the amplifier (with short lead lengths to power supply common) will assure adequate high frequency bypassing, in most applications.



LT1122-TA03

When the feedback around the op amp is resistive ( $R_F$ ), a pole will be created with  $R_F$ , the source resistance and capacitance ( $R_S$ ,  $C_S$ ), and the amplifier input capacitance ( $C_{IN} \approx 4pF$ ). In low closed loop gain configurations and with  $R_S$  and  $R_F$  in the kilohm range, this pole can create excess phase shift and even oscillation. A small capacitor ( $C_F$ ) in parallel with  $R_F$  eliminates this problem. With  $R_S (C_S + C_{IN}) = R_F C_F$ , the effect of the feedback pole is completely removed.



LT1122-TA04

